

TOSHIBA CMOS DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

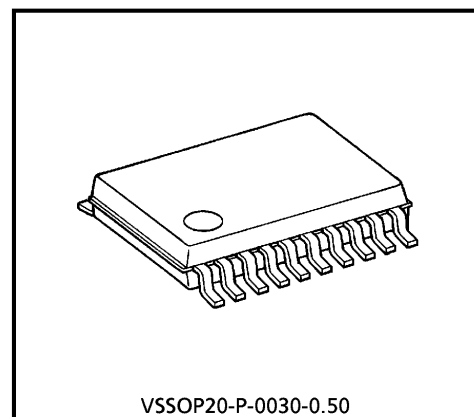
**TC7MA2541FK****LOW-VOLTAGE OCTAL BUS BUFFER  
WITH 3.6 V TOLERANT INPUTS AND OUTPUTS**

The TC7MA2541FK is a high performance CMOS OCTAL BUS BUFFER. Designed for use in 1.8, 2.5 or 3.3 Volt systems, it achieves high speed operation while maintaining the CMOS low power dissipation. It is also designed with over voltage tolerant inputs and outputs up to 3.6 V.

This device is a non-inverting 3-state buffer having two active-low output enables. When either  $\overline{OE}1$  or  $\overline{OE}2$  are high, the terminal outputs are in the high-impedance state. This device is designed to be used with 3-state memory address drivers, etc.

The 26- $\Omega$  series resistor helps reducing output overshoot and undershoot without external resistor.

All inputs are equipped with protection circuits against static discharge.



VSSOP20-P-0030-0.50

Weight : 0.03 g (typ.)

**Features**

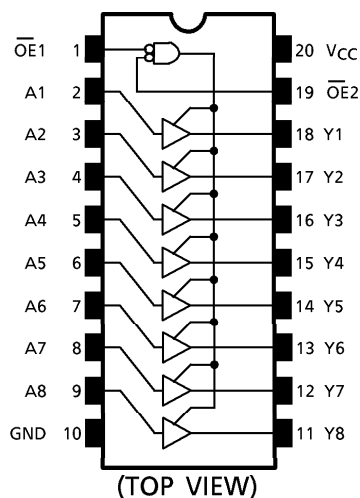
- 26- $\Omega$  Series Resistors on Outputs.
- Low Voltage Operation :  $V_{CC} = 1.8\sim 3.6$  V
- High Speed Operation :  $t_{pd} = 4.4$  ns (max) at  $V_{CC} = 3.0\sim 3.6$  V  
 $t_{pd} = 5.6$  ns (max) at  $V_{CC} = 2.3\sim 2.7$  V  
 $t_{pd} = 9.8$  ns (max) at  $V_{CC} = 1.8$  V
- 3.6 V Tolerant inputs and output.
- Output Current :  $I_{OH}/I_{OL} = \pm 12$  mA (min) at  $V_{CC} = 3.0$  V  
 $I_{OH}/I_{OL} = \pm 8$  mA (min) at  $V_{CC} = 2.3$  V  
 $I_{OH}/I_{OL} = \pm 4$  mA (min) at  $V_{CC} = 1.8$  V
- Latch-up Performance :  $\pm 300$  mA
- ESD Performance : Human Body Model  $> \pm 2000$  V  
Machine Model  $> \pm 200$  V
- Package : VSSOP (US20)
- Power Down Protection is provided on all inputs and outputs.
- Supports live insertion / withdrawal (Note 1)

(Note 1): To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sourcing capability of the driver.

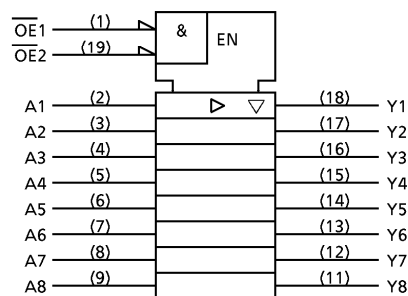
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Pin Assignment



IEC Logic Symbol



Truth Table

INPUTS			OUTPUTS
OE1	OE2	An	
H	X	X	Z
X	H	X	Z
L	L	H	H
L	L	L	L

X : Don't Care  
Z : High Impedance

Maximum Ratings

PARAMETER	SYMBOL	RATING	UNIT
Power Supply Voltage	V <sub>CC</sub>	-0.5~4.6	V
DC Input Voltage	V <sub>IN</sub>	-0.5~4.6	V
DC Output Voltage	V <sub>OUT</sub>	-0.5~4.6 (Note 1)	V
		-0.5~V <sub>CC</sub> + 0.5 (Note 2)	
Input Diode Current	I <sub>IJK</sub>	-50	mA
Output Diode Current	I <sub>OK</sub>	±50 (Note 3)	mA
DC Output Current	I <sub>OUT</sub>	±50	mA
Power Dissipation	P <sub>D</sub>	180	mW
DC V <sub>CC</sub> /Ground Current	I <sub>CC</sub> /I <sub>GND</sub>	±100	mA
Storage Temperature	T <sub>stg</sub>	-65~150	°C

(Note 1): Off-State

(Note 2): High or Low State. I<sub>OUT</sub> absolute maximum rating must be observed.

(Note 3): V<sub>OUT</sub> < GND, V<sub>OUT</sub> > V<sub>CC</sub>

**Recommended Operating Range**

PARAMETER	SYMBOL	RATING	UNIT
Supply Voltage	V <sub>CC</sub>	1.8~3.6	V
		1.2~3.6 (Note 4)	
Input Voltage	V <sub>IN</sub>	-0.3~3.6	V
Output Voltage	V <sub>OUT</sub>	0~3.6 (Note 5)	V
		0~V <sub>CC</sub> (Note 6)	
Output Current	I <sub>OH</sub> /I <sub>OL</sub>	±12 (Note 7)	mA
		±8 (Note 8)	
		±4 (Note 9)	
Operating Temperature	T <sub>opr</sub>	-40~85	°C
Input Rise And Fall Time	dt/dv	0~10 (Note 10)	ns/V

(Note 4): Data Retention Only

(Note 5): Off-State

(Note 6): High or Low State

(Note 7): V<sub>CC</sub> = 3.0~3.6 V

(Note 8): V<sub>CC</sub> = 2.3~2.7 V

(Note 9): V<sub>CC</sub> = 1.8 V

(Note 10): V<sub>IN</sub> = 0.8~2.0 V, V<sub>CC</sub> = 3.0 V

**Electrical Characteristics**

DC characteristics (Ta = -40~85°C, 2.7 V < V<sub>CC</sub> ≤ 3.6 V)

PARAMETER		SYMBOL	TEST CONDITION	V <sub>CC</sub> (V)	Min	Max	UNIT
Input Voltage	"H" Level	V <sub>IH</sub>		2.7~3.6	2.0	—	V
	"L" Level	V <sub>IL</sub>		2.7~3.6	—	0.8	
Output Voltage	"H" Level	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -100 μA	2.7~3.6	V <sub>CC</sub> - 0.2	V
				I <sub>OH</sub> = -6 mA	2.7	2.2	
				I <sub>OH</sub> = -8 mA	3.0	2.4	
				I <sub>OH</sub> = -12 mA	3.0	2.2	
	"L" Level	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 100 μA	2.7~3.6	—	0.2
				I <sub>OL</sub> = 6 mA	2.7	—	0.4
				I <sub>OL</sub> = 8 mA	3.0	—	0.55
				I <sub>OL</sub> = 12 mA	3.0	—	0.8
Input Leakage Current	I <sub>IN</sub>	V <sub>IN</sub> = 0~3.6 V	2.7~3.6	—	±5.0	μA	
3-State Output Off-State Current	I <sub>OZ</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> V <sub>OUT</sub> = 0~3.6 V	2.7~3.6	—	±10.0	μA	
Power Off Leakage Current	I <sub>OFF</sub>	V <sub>IN</sub> , V <sub>OUT</sub> = 0~3.6 V	0	—	10.0	μA	
Quiescent Supply Current	I <sub>CC</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND	2.7~3.6	—	20.0	μA	
		V <sub>CC</sub> ≤ (V <sub>IN</sub> , V <sub>OUT</sub> ) ≤ 3.6 V	2.7~3.6	—	±20.0		
Increase In I <sub>CC</sub> Per Input	ΔI <sub>CC</sub>	V <sub>IH</sub> = V <sub>CC</sub> - 0.6 V	2.7~3.6	—	750	μA	

**Electrical Characteristics**

DC characteristics (Ta = -40~85°C, 2.3 V ≤ VCC ≤ 2.7 V)

PARAMETER		SYMBOL	TEST CONDITION		VCC (V)	Min	Max	UNIT
					2.3~2.7			
Input Voltage	"H" Level	V <sub>IH</sub>			2.3~2.7	1.6	—	V
	"L" Level	V <sub>IL</sub>			2.3~2.7	—	0.7	
Output Voltage	"H" Level	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -100 μA	2.3~2.7	V <sub>CC</sub> - 0.2	—	V
				I <sub>OH</sub> = -4 mA	2.3	2.0	—	
				I <sub>OH</sub> = -6 mA	2.3	1.8	—	
				I <sub>OH</sub> = -8 mA	2.3	1.7	—	
	"L" Level	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 100 μA	2.3~2.7	—	0.2	
				I <sub>OL</sub> = 6 mA	2.3	—	0.4	
I <sub>OL</sub> = 8 mA				2.3	—	0.6		
Input Leakage Current		I <sub>IN</sub>	V <sub>IN</sub> = 0~3.6 V		2.3~2.7	—	± 5.0	μA
3-State Output Off-State Current		I <sub>OZ</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> V <sub>OUT</sub> = 0~3.6 V		2.3~2.7	—	± 10.0	μA
Power Off Leakage Current		I <sub>OFF</sub>	V <sub>IN</sub> , V <sub>OUT</sub> = 0~3.6 V		0	—	10.0	μA
Quiescent Supply Current		I <sub>CC</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		2.3~2.7	—	20.0	μA
			V <sub>CC</sub> ≤ (V <sub>IN</sub> , V <sub>OUT</sub> ) ≤ 3.6 V		2.3~2.7	—	± 20.0	

**Electrical Characteristics**

DC characteristics (Ta = -40~85°C, 1.8 V ≤ VCC < 2.3 V)

PARAMETER		SYMBOL	TEST CONDITION		VCC (V)	Min	Max	UNIT
Input Voltage	"H" Level	V <sub>IH</sub>			1.8~2.3	0.7 × V <sub>CC</sub>	—	V
	"L" Level	V <sub>IL</sub>			1.8~2.3	—	0.2 × V <sub>CC</sub>	
Output Voltage	"H" Level	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -100 μA	1.8	V <sub>CC</sub> - 0.2	—	V
				I <sub>OH</sub> = -4 mA	1.8	1.4	—	
	"L" Level	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 100 μA	1.8	—	0.2	
				I <sub>OL</sub> = 4 mA	1.8	—	0.3	
Input Leakage Current		I <sub>IIN</sub>	V <sub>IN</sub> = 0~3.6 V		1.8	—	± 5.0	μA
3-State Output Off-State Current		I <sub>OZ</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> V <sub>OUT</sub> = 0~3.6 V		1.8	—	± 10.0	μA
Power Off Leakage Current		I <sub>OFF</sub>	V <sub>IN</sub> , V <sub>OUT</sub> = 0~3.6 V		0	—	10.0	μA
Quiescent Supply Current		I <sub>CC</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		1.8	—	20.0	μA
			V <sub>CC</sub> ≤ (V <sub>IN</sub> , V <sub>OUT</sub> ) ≤ 3.6 V		1.8	—	± 20.0	

AC characteristics (Ta = -40~85°C, Input t<sub>r</sub> = t<sub>f</sub> = 2.0 ns, C<sub>L</sub> = 30 pF, R<sub>L</sub> = 500 Ω)

PARAMETER	SYMBOL	TEST CONDITION	VCC (V)	Min	Max	UNIT
Propagation Delay Time	t <sub>pLH</sub> t <sub>pHL</sub>	(Fig.1, 2)	1.8	1.5	9.8	ns
			2.5 ± 0.2	0.8	5.6	
			3.3 ± 0.3	0.6	4.4	
3-State Output Enable Time	t <sub>pZL</sub> t <sub>pZH</sub>	(Fig.1, 3)	1.8	1.5	9.8	ns
			2.5 ± 0.2	0.8	6.5	
			3.3 ± 0.3	0.6	5.0	
3-State Output Disable Time	t <sub>pLZ</sub> t <sub>pHZ</sub>	(Fig.1, 3)	1.8	1.5	7.7	ns
			2.5 ± 0.2	0.8	4.3	
			3.3 ± 0.3	0.6	3.9	
Output To Output Skew	t <sub>osLH</sub> t <sub>osHL</sub>	(Note 11)	1.8	—	0.5	ns
			2.5 ± 0.2	—	0.5	
			3.3 ± 0.3	—	0.5	

For C<sub>L</sub> = 50 pF, add approximately 300 ps to the AC maximum specification.

(Note 11): Parameter guaranteed by design.

$$(t_{osLH} = |t_{pLHm} - t_{pLHn}|, t_{osHL} = |t_{pHLm} - t_{pHLn}|)$$

Dynamic switching characteristics (Ta = 25°C, Input  $t_r = t_f = 2.0$  ns,  $C_L = 30$  pF)

PARAMETER	SYMBOL	TEST CONDITION	V <sub>CC</sub> (V)	Typ.	UNIT
Quiet Output Maximum Dynamic V <sub>OL</sub>	V <sub>OLP</sub>	V <sub>IH</sub> = 1.8 V, V <sub>IL</sub> = 0 V (Note 12)	1.8	0.15	V
		V <sub>IH</sub> = 2.5 V, V <sub>IL</sub> = 0 V (Note 12)	2.5	0.25	
		V <sub>IH</sub> = 3.3 V, V <sub>IL</sub> = 0 V (Note 12)	3.3	0.35	
Quiet Output Minimum Dynamic V <sub>OL</sub>	V <sub>OLV</sub>	V <sub>IH</sub> = 1.8 V, V <sub>IL</sub> = 0 V (Note 12)	1.8	-0.15	V
		V <sub>IH</sub> = 2.5 V, V <sub>IL</sub> = 0 V (Note 12)	2.5	-0.25	
		V <sub>IH</sub> = 3.3 V, V <sub>IL</sub> = 0 V (Note 12)	3.3	-0.35	
Quiet Output Minimum Dynamic V <sub>OH</sub>	V <sub>OHV</sub>	V <sub>IH</sub> = 1.8 V, V <sub>IL</sub> = 0 V (Note 12)	1.8	1.55	V
		V <sub>IH</sub> = 2.5 V, V <sub>IL</sub> = 0 V (Note 12)	2.5	2.05	
		V <sub>IH</sub> = 3.3 V, V <sub>IL</sub> = 0 V (Note 12)	3.3	2.65	

(Note 12): Parameter guaranteed by design.

Capacitive characteristics (Ta = 25°C)

PARAMETER	SYMBOL	TEST CONDITION	V <sub>CC</sub> (V)	Typ.	UNIT
Input Capacitance	C <sub>IN</sub>		1.8, 2.5, 3.3	6	pF
Output Capacitance	C <sub>OUT</sub>		1.8, 2.5, 3.3	7	pF
Power Dissipation Capacitance	C <sub>PD</sub>	f <sub>IN</sub> = 10 MHz (Note 13)	1.8, 2.5, 3.3	20	pF

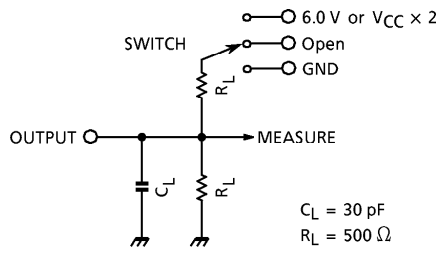
(Note 13): C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation :

$$I_{CC(opr.)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8 \text{ (per bit)}$$

**Test Circuit**

Fig.1



PARAMETER	SWITCH
$t_{pLH}, t_{pHL}$	Open
$t_{pLZ}, t_{pZL}$	6.0 V @ $V_{CC} = 3.3 \pm 0.3$ V $V_{CC} \times 2$ @ $V_{CC} = 2.5 \pm 0.2$ V @ $V_{CC} = 1.8$ V
$t_{pHZ}, t_{pZH}$	GND

**AC Waveform**

Fig.2  $t_{pLH}, t_{pHL}$

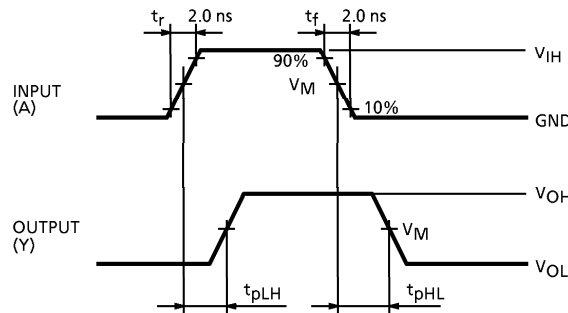
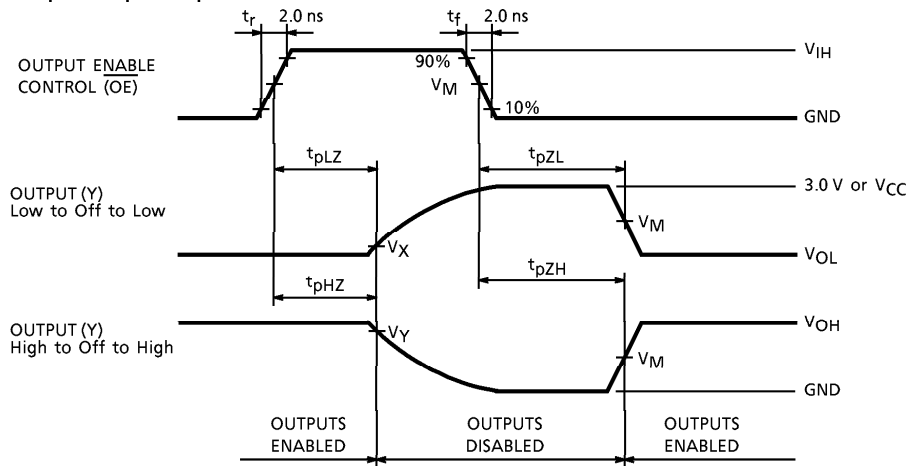


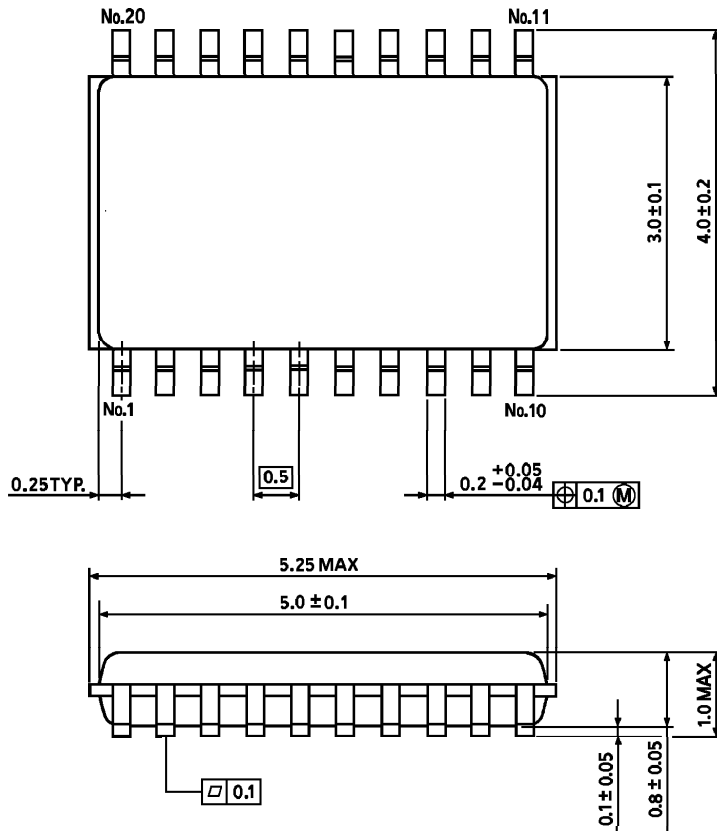
Fig.3  $t_{pLZ}, t_{pHZ}, t_{pZL}, t_{pZH}$



SYMBOL	$V_{CC}$		
	$3.3 \pm 0.3$ V	$2.5 \pm 0.2$ V	1.8 V
$V_{IH}$	2.7 V	$V_{CC}$	$V_{CC}$
$V_M$	1.5 V	$V_{CC} / 2$	$V_{CC} / 2$
$V_X$	$V_{OL} + 0.3$ V	$V_{OL} + 0.15$ V	$V_{OL} + 0.15$ V
$V_Y$	$V_{OH} - 0.3$ V	$V_{OH} - 0.15$ V	$V_{OH} - 0.15$ V

Outline Drawing  
VSSOP20-P-0030-0.50

Unit : mm



Weight : 0.03 g (typ.)